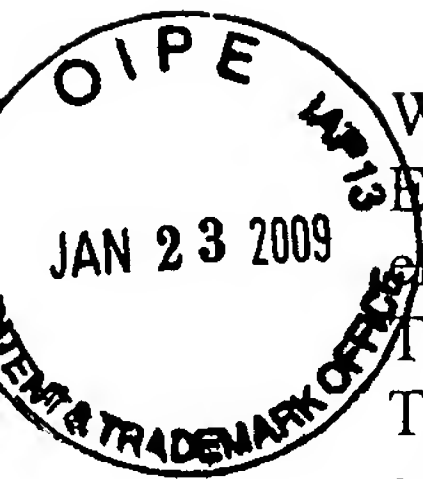Docket <u>KNJ-217-A</u>

SUPPLEMENTAL DECLARATION

We, Hidekazu Kodama, Munehiro Date, Pavel Mokry, Kazunori Kimura, Tomonao Okubo, and Eiichi Fukada, as the inventors named in the application for letters patent for an improvement entitled SOUND INSULATION/ABSORPTION STRUCTURE, AND STRUCTURE HAVING THESE APPLIED THERETO, Serial No.10/562,924, filed in the United States Patent And Trademark Office on 27 December 2005, hereby declare that the subject matter of the amendments filed on or about 07 November 2007, and 19 September 2008 were part of our invention and was invented by us before the 27 May 2005 filing of PCT/JP2004/007639, of which USSN 10/562,924 is the National Phase application in the United States; and before the 27 December 2003 filing of the Japanese Patent Application 2003-151871, both from which the U.S. application identified above claims priority.

ACKNOWLEDGMENT OF REVIEW OF PAPERS AND DUTY OF CANDOR

We hereby state that we have reviewed and understand the contents of the above-identified specification, including the claims as amended by any amendment referred to above.

We acknowledge the duty to disclose information, which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, §1.56(a).

We hereby declare that all statements made herein of our own knowledge are true and that all statements made on information and belief are believed to be true; and, further, that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

_____
Hidekazu Kodama

2008/11/10
_____
Date

_____
Munehiro Date

2008/10/28
_____
Date

_____
Pavel Mokry

2008/11/27
_____
Date

_____
Kazunori Kimura

2008/11/10
_____
Date

_____
Tomonao Okubo

2008/11/10
_____
Date

_____
Eiichi Fukada

2008/11/10
_____
Date

JPC/nmc